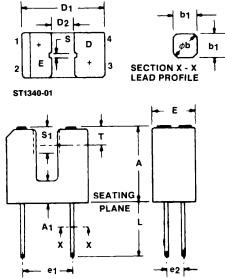


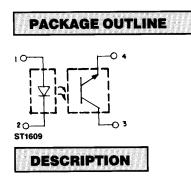
SEMICONDUCTOR

H22A1/2/3

PACKAGE DIMENSIONS



ST1340-02



The H22A Slotted Optical Switch is a gallium arsenide light emitting diode coupled to a silicon photodarlington in a plastic housing. The packaging system is designed to optimize the mechanical resolution, coupling efficiency, ambient light rejection, cost and reliability. The gap in the housing provides a means of interrupting the signal with an opaque material, switching the output from an "ON" to an "OFF" state.

		ETEDO		HES		
SYMBOL	MILLIMETERS			NOTES		
	MIN.	MAX.	MIN.	MAX.		
A	10.7	11.0	.422	.433		
A ₁	3.0	3.2	.119	.125		
@b	.600	.750	.024	.030	2	
b,	.50 NOM.		.020 NOM.		2	
D,	11.6	12.0	.457	.472		
D ₂	3.0	3.3	.119	.129		
e,	6.9	7.5	.272	.295		
e2	2.3	2.8	.091	.110		
E	6.15	6.35	.243	.249		
L	8.00		.315			
S	.85	1.0	.034	.039		
S 1	3.45	3.75	.136	.147		
Т	2.61	2.6 NOM.		.103 NOM.		

NOTES:

- 1. INCH DIMENSIONS ARE DERIVED FROM MILLIMETERS.
- 2. FOUR LEADS. LEAD CROSS SECTION IS CONTROLLED BETWEEN 1.27mm (.050") FROM SEATING PLANE AND THE END OF THE LEADS.
- 3. THE SENSING AREA IS DEFINED BY THE "S" DIMENSION AND BY DIMENSION "T" ±0.75mm (±.030 INCH).

FEATURES

- Opaque housing
- Low cost
- .035" apertures
- High I_{C(ON)}



SEMICONDUCTOR

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C U Storage Temperature	
Operating Temperature	
Soldering: Lead Temperature (Iron) Lead Temperature (Flow)	
INPUT DIODE	
Continuous Forward Current	
Reverse Voltage	
Power Dissipation	
OUTPUT TRANSISTOR	
Collector-Emitter Voltage	
Emitter-Collector Voltage	
Power Dissipation	

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
INPUT DIODE						
Forward Voltage	VF			1.7	V	$I_F = 60 \text{ mA}$
Reverse Breakdown Voltage	V _R	6.0			V	$I_{R} = 10 \mu A$
Reverse Leakage Current	l _R			1.0	μA	$V_{R} = 3 V$
OUTPUT TRANSISTOR	2.5 geo. ()					
Emitter-Collector Breakdown	BVECO	6.0		_	V	$I_{E} = 100 \ \mu A, Ee = 0$
Collector-Emitter Breakdown	BV _{CEO}	30			V	$I_c = 1 \text{ mA}, \text{ Ee} = 0$
Collector-Emitter Leakage	I _{CEO}	_	125	100	nA	$V_{ce} = 25 V$, $Ee = 0$
COUPLED						1,244
On-State Collector Current	I _{C(ON)} See page 3.			mA		
Saturation Voltage	V _{CE(SAT)}	See page 3.		V		
Turn-On Time	t _{on}	See page 3.		μS	r.	
Turn-Off Time	t _{off}		See page 3.		μS	

NOTES

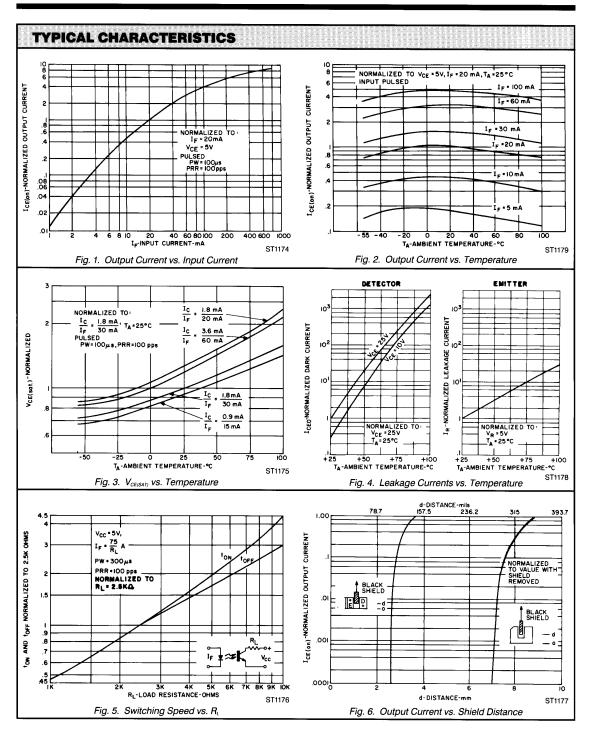
Derate power dissipation linearly 1.33 mW/°C above 25°C.
 Derate power dissipation linearly 2.00 mW/°C above 25°C.
 RMA flux is recommended.

- Michanol or Isopropyl alcohols are recommended as cleaning agents.
 Soldering iron tip 1/e" (1.6 mm) from housing.



ICIONIS VCE(SAT)S tons A	ND t _{off}					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
ON-STATE COLLECTO	RCURRENT					
H22A1	I _{C(ON)}	0.15	—	_	mA	$I_F = 5mA$, $V_{CE} = 5V$
H22A2	I _{C(ON)}	0.30	_		mA	$I_F = 5mA$, $V_{CE} = 5V$
H22A3	I _{C(ON)}	0.60			mA	$I_{\rm F} = 5 {\rm mA}$, $V_{\rm CE} = 5 {\rm V}$
H22A1		1.0		_	mA	$I_{\rm F} = 20 {\rm mA}, V_{\rm CE} = 5 {\rm V}$
H22A2	I _{C(ON)}	2.0			mA	$I_F = 20 \text{mA}, V_{CE} = 5 \text{V}$
H22A3	C(ON)	4.0			mA	$I_{\rm F}=20mA,V_{\rm CE}=5V$
H22A1		1.9		_	mA	$I_{\rm F} = 30 {\rm mA}, V_{\rm CE} = 5 {\rm V}$
H22A2	I _{C(ON)}	3.0		_	mA	$I_{\rm F} = 30 {\rm mA}, V_{\rm CE} = 5 {\rm V}$
H22A3		5.5			mA	$I_F = 30 \text{mA}, V_{CE} = 5 \text{V}$
SATURATION VOLTAG	E					
H22A2		_		0.40	V	$I_{\rm F} = 20 {\rm mA}, I_{\rm c} = 1.8 {\rm mA}$
H22A3	$V_{\text{CE(SAT)}}$			0.40	V	$I_{\rm F} = 20 {\rm mA}, I_{\rm C} = 1.8 {\rm mA}$
H22A1	V _{CE(SAT)}		·	0.40	V	$I_{\rm F} = 30$ mA, $I_{\rm C} = 1.8$ mA
Turn-On Time	t _{on}		8		μS	$V_{cc} = 5V, I_F = 30 \text{ mA}, R_L = 2.5Ks$
Turn-Off Time	t _{off}	_	50		μS	$V_{cc} = 5V$, $I_{E} = 30$ mA, $R_{L} = 2.5KG$





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